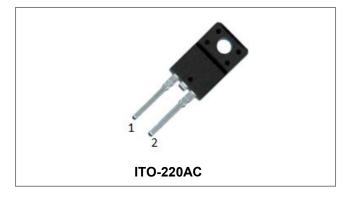


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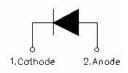
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MBRF10150 SCHOTTKY RECTIFIER



Circuit Diagram



Features

- 175°C T_J operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Center tap configuration

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	150	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=155°C, rectangular wave form	10	А
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3ms, Half Sine pulse	138	А

Electrical Characteristics:

Characteristics	Symbol	Symbol Condition		Max.	Units
Forward Voltage Drop*	V _{F1}	@ 10A, Pulse, TJ = 25 °C	0.80	1.10	V
	V _{F2}	@ 10A, Pulse, T _J = 125 °C	0.68	0.86	V
Reverse Current*	I _{R1}	$@V_R = rated V_{R,} T_J = 25 \ ^{\circ}C$	0.001	1.0	mA
	I _{R2}	$@V_R = rated V_{R, T_J} = 125 \circ C$	0.1	7.0	mA
Non-Repetitive Avalanche Energy	E _{AS}	$E_{AS} \qquad \begin{array}{c} T_J = 25 \text{ °C}, I_{AS} = 2 \text{ A}, \\ L = 1 \text{ mH} \end{array}$		2	mJ
Junction Capacitance	Ст	C _T @V _R = 5V, T _C = 25 °C f _{SIG} = 1MHz		400	pF
Series Inductance	Ls	Measured lead to lead 5 mm from package body	8	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

* Pulse width < 300 μs, duty cycle < 2%



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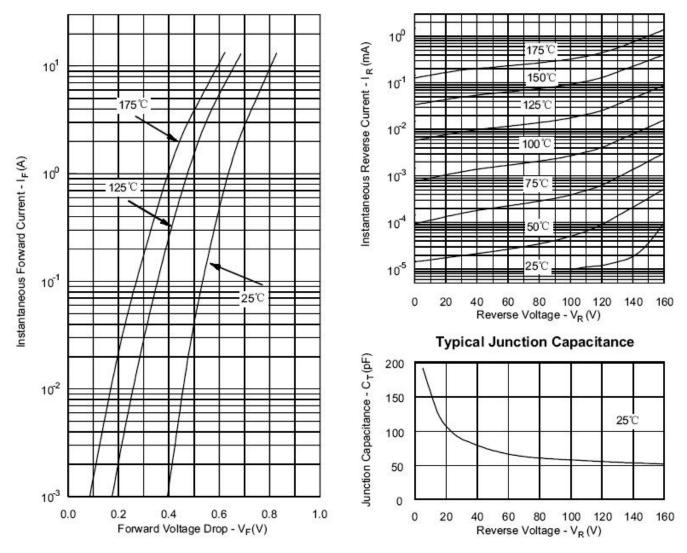
Typical Reverse Characteristics

RoHS P

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	DC operation	3.5	°C/W
Approximate Weight	wt	-	1.6	g
Case Style	ITO-220AC			

Ratings and Characteristics Curves



Typical Forward Characteristics

China - Germany - Korea - Singapore - United States http://www.smc-diodes.com - sales@ smc-diodes.com -

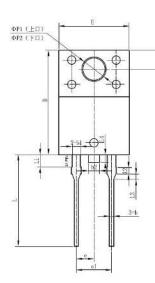


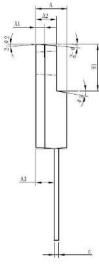
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RoHS 🗭

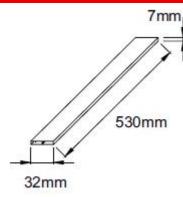
Mechanical Dimensions ITO-220AC



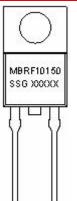


SYMBOL	Millimeters				
STMBOL	MIN.	TYP.	MAX.		
A	4.30	4.50	4.70		
A1	1.10	1.30	1.50		
A2	2.80	3.00	3.20		
A3	2.50	2.70	2.90		
b	0.50	0.60	0.75		
b1	1.10	1.20	1.35		
b2	1.50	1.60	1.75		
С	0.55	0.60	0.75		
D	14.80	15.00	15.20		
E	9.96	10.16	10.36		
е	-	2.55	-		
e1	-	5.10	-		
H1	6.50	6.70	6.90		
L	12.70	13.20	13.70		
L1	1.60	1.80	2.00		
L2	0.80	1.00	1.20		
L3	0.60	0.80	1.00		
L4	-	1.10	1.50		
ΦΡ1(上口)	3.30	3.50	3.70		
ΦΡ2 (下口)	2.99	3.19	3.39		
Q	2.50	2.70	2.90		
Θ1		5°			
Θ2		4°			
Θ3		10°			
Θ4		5°			
Θ5		5°			

Tube Specification



Marking Diagram



Where XXXXX is YYWWL

MBR

F

10

150

SSG

YΥ

WW

L

- = Device Type
- = Package type
- = Forward Current (10A) = Reverse Voltage (150V)
- = SSG
- = Year
- = Week
- = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Ordering Information

Device	Package	Shipping	
MBRF10150	ITO-220AC (Pb-Free)	50 pcs/ tube	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

China - Germany - Korea - Singapore - United States http://www.smc-diodes.com - sales@ smc-diodes.com -



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